

RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP : RA6M4

DEVICE : R7FA6M4XXX

QUALITY GRADE : Standard

Quality Assurance Div.
Renesas Electronics Corporation

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Summary of Reliability Test Results for QFP Package (MSL3)

Test Item	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 °C, Vccmax, 1000 hrs	0/231	3 lots or more
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 °C, 1000 hrs	0/75	3 lots or more
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 °C, RH=85 %, Vccmax, 1000 hrs	0/75	3 lots or more
Temperature Humidity bias (HAST) (*1)	JESD22-A110	Ta=110 °C, RH=85 %, Vccmax, 264 hrs	0/75	3 lots or more
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 °C to 150 °C , 500 cycles	0/75	3 lots or more
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500 V, 1 time	0/3	Class: C2
Solderability (SD)	J-STD-002	245 °C, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (MSL3)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3) Peak Reflow Temp=260 °C	Pass	Verified after MSL preconditioning; applied to applicable reliability tests (*1).

Note :

- (*1) With preconditioning per JESD22-A113, MSL 3
- It is tested to confirm that all the samples are satisfied with an individual product specification.
- Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

Summary of Reliability Test Results for BGA Package (MSL3)

Test Item	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 °C, Vccmax, 1000 hrs	0/231	3 lots or more
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 °C, 1000 hrs	0/75	3 lots or more
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 °C, RH=85 %, Vccmax, 1000 hrs	0/25	
Temperature Humidity bias (HAST) (*1)	JESD22-A110	Ta=110 °C, RH=85 %, Vccmax, 264 hrs	0/75	3 lots or more
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-55 °C to 125 °C , 700 cycles	0/75	3 lots or more
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500 V, 1 time	0/3	Class: C2
Resistance to Soldering Heat (MSL3)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3) Peak Reflow Temp=260 °C	Pass	Verified after MSL preconditioning; applied to applicable reliability tests (*1).

Note :

- (*1) With preconditioning per JESD22-A113, MSL 3
- It is tested to confirm that all the samples are satisfied with an individual product specification.
- Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

The failure rate of the device in an actual use condition can be estimated by the below procedure.

•Equation for the failure rate estimation (λ)

$$\lambda = \lambda b \times \pi T \text{ (FIT)}$$

①Unique failure rate (λb)

$\lambda b= 0.007 \text{ FIT}$

Unique failure rate at $Ta=55\text{ }^{\circ}\text{C}$ using 60 % confidence level.

②Temperature term (πT)

$\pi T=exp\{11600\times Ea\times(1/(273+55)-1/(273+Ta))\}$

Ea : Activation energy (eV)
 Ta : Ambient temperature ($^{\circ}\text{C}$)

πT simplified chart as $Ea=0.7\text{ eV}$												
Ta ($^{\circ}\text{C}$)	40	50	55	60	65	70	75	80	85	90	100	110
πT	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

•MTTF (Mean Time To Failure)

$$MTTF = 1/\lambda$$

Reference about Renesas package code

Package type		Package code *1
Lead type plastic package	QFP	PxQP
	SOP	PxSP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG
Wafer level chip scale package	WLCSP	SxBG

*1. First four digit

Table. Product list

No	Product part number	Package code	MSL	No	Product part number	Package code	MSL
1	R7FA6M4AD2CBM	PLBG0144K*	MSL3	51			
2	R7FA6M4AD3CBM	PLBG0144K*	MSL3	52			
3	R7FA6M4AE2CBM	PLBG0144K*	MSL3	53			
4	R7FA6M4AE3CBM	PLBG0144K*	MSL3	54			
5	R7FA6M4AF2CBM	PLBG0144K*	MSL3	55			
6	R7FA6M4AF3CBM	PLBG0144K*	MSL3	56			
7	R7FA6M4AD2CBQ	PLBG0064J*	MSL3	57			
8	R7FA6M4AD3CBQ	PLBG0064J*	MSL3	58			
9	R7FA6M4AE2CBQ	PLBG0064J*	MSL3	59			
10	R7FA6M4AE3CBQ	PLBG0064J*	MSL3	60			
11	R7FA6M4AF2CBQ	PLBG0064J*	MSL3	61			
12	R7FA6M4AF3CBQ	PLBG0064J*	MSL3	62			
13	R7FA6M4AD3CFB	PLQP0144K*	MSL3	63			
14	R7FA6M4AE3CFB	PLQP0144K*	MSL3	64			
15	R7FA6M4AF3CFB	PLQP0144K*	MSL3	65			
16	R7FA6M4AD3CFM	PLQP0064K*	MSL3	66			
17	R7FA6M4AE3CFM	PLQP0064K*	MSL3	67			
18	R7FA6M4AF3CFM	PLQP0064K*	MSL3	68			
19	R7FA6M4AD3CFP	PLQP0100K*	MSL3	69			
20	R7FA6M4AE3CFP	PLQP0100K*	MSL3	70			
21	R7FA6M4AF3CFP	PLQP0100K*	MSL3	71			
22				72			
23				73			
24				74			
25				75			
26				76			
27				77			
28				78			
29				79			
30				80			
31				81			
32				82			
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36				86			
37				87			
38				88			
39				89			
40				90			
41				91			
42				92			
43				93			
44				94			
45				95			
46				96			
47				97			
48				98			
49				99			
50				100			

Note: MSL stands for Moisture Sensitivity Level.